

## **Small Signal Product**

## **DUAL Digital Transistor(NPN+NPN)**

### **FEATURES**

- Epitaxial planar die construction
- Surface device type mounting
- Two DTC114E chip in a package
- Transistor elements are independent, eliminating interference
- Mounting cost and area be cut in half
- Pb free version and RoHS compliant
- Packing code with suffix "G" means green compound (halogen-free)

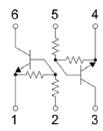






### **MECHANICAL DATA**

- Case: SOT-363 small outline plastic package
- Moisture sensitivity level 1
- Terminal: Pure tin plated, lead free., solderable per MIL-STD-202, Method 208 guaranteed
- Weight: 7.1 ± 0.5 mgMarking Code: H11



**SOT-363** 

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)				
PARAMETER	SYMBOL	VALUE	UNIT	
Supply voltage	Vcc	50	V	
Input voltage	V <sub>IN</sub>	-10~40	V	
Output current	lo	50	mA	
Output current	I <sub>C(max)</sub>	100	mA	
Power dissipation	Pd	150	mW	
Junction Temperature	T <sub>J</sub>	150	°C	
Storage Temperature Range	T <sub>STG</sub>	- 55 to +150	°C	

PA	SYMBOL	MIN	TYP	MAX	UNIT	
Input voltage	Vcc=5V, Io=100uA	$V_{I(off)}$			0.5	V
Input voltage	Vo=0.3V, Io=10mA	$V_{I(on)}$	3			V
Output voltage	lo/l <sub>I</sub> =10mA/0.5mA	$V_{O(on)}$		0.1	0.3	V
Input current	V <sub>I</sub> =5V	l <sub>l</sub>			0.88	mA
Onput current	Vcc=50V, V <sub>I</sub> =0	I <sub>O(off)</sub>			0.5	uA
DC current gain	Vo=5V, Io=5mA	Gı	30			
Input resistance	-	R <sub>1</sub>	7	10	13	ΚΩ
Resistance ratio	-	R <sub>2</sub> /R <sub>1</sub>	0.8	1	1.2	
Transition frequency	V <sub>CE</sub> =10V, I <sub>E</sub> =5mA, f=100MHz	f <sub>T</sub>		250		MHz



# **Small Signal Product**

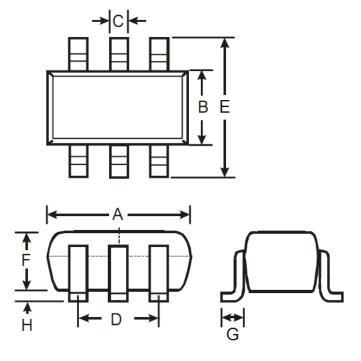
ORDERING INFORMATION				
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
UMH11N (Note 1)	RE	G	SOT-363	3K / 7" Reel

Note 1: Whole series with green compound

EXAMPLE				
PREFERRED P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
UMH11N REG	UMH11N	RE	G	Green compound

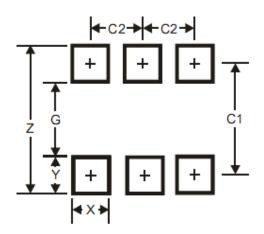
## **DIMENSIONS**

## **SOT-363**



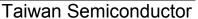
DIM. Unit (mi		Unit (mm)		(inch)
DIIVI.	Min	Max	Min	Max
Α	2.00	2.20	0.079	0.087
В	1.15	1.35	0.045	0.053
С	0.15	0.35	0.006	0.014
D	1.20	1.40	0.047	0.055
Е	2.15	2.45	0.085	0.096
F	0.85	1.05	0.033	0.041
G	0.25	0.46	0.010	0.018
Н	0.00	0.10	0.000	0.004

## **SUGGESTED PAD LAYOUT**



DIM.	Unit (mm)	Unit (inch)	
DIIVI.	Тур.	Тур.	
Z	2.50	0.098	
G	1.30	0.051	
Х	0.42	0.017	
Υ	0.60	0.024	
C1	1.90	0.075	
C2	0.65	0.026	







**Small Signal Product** 

#### **Notice**

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

Document Number: DS\_S0000016 Version: D15